Microchip Filter specification TFS 300K 1/5

**Measurement condition** 

Ambient temperature: 23 °C Input power level: 0 dBm Terminating impedance: \*

#### Characteristics

#### Remark:

The reference level for the relative attenuation  $a_{rel}$  of the TFS300K is the minimum of the pass band attenuation  $a_{min}$ . The minimum of the pass band attenuation  $a_{min}$  is defined as the insertion loss  $a_e$ . The centre frequency  $f_c$  is the arithmetic mean value of the upper and lower frequencies at the 3 dB filter attenuation level relative to the insertion loss  $a_e$ . The nominal frequency  $f_N$  is fixed at 300,0 MHz without any tolerance. The given values for both the relative attenuation  $a_{rel}$  and the group delay ripple have to be achieved at the frequencies given below even if the centre frequency  $f_C$  is shifted due to the temperature coefficient of frequency  $TC_f$  in the operating temperature range and due to a production tolerance for the centre frequency  $f_C$ .

Data		typ. v	/alue	tole	ance / I	imit
Insertion loss (reference level)	a <sub>e</sub>	3,1		max.	6,5	dB
Nominal frequency	$f_N$	=			300,00	MHz
Centre frequency	$f_{C}$	300,01	MHz		-	
Passband	РВ	=		f <sub>N</sub> ±	70,0	kHz
Bandwidth	BW					
3 dB		306	kHz	min.	280	kHz
Relative attenuation	a <sub>rel</sub>					
f <sub>N</sub> ± 400 kHz		32	dB	min.	15	dB
$f_N \pm 400$ kHz $f_N \pm 600$	kHz	32	dB	min.	27	dB
$f_N \pm 600$ kHz $f_N \pm 13$	MHz	47	dB	min.	35	dB
$f_N \pm 100 MHz$		60	dB	min.	58	dB
Group delay ripple within PB		0,9	μs	max.	2	μS
Input power level		=		max.	15	dBm
Operating temperature range	OTR	-		- 20 °C	. + 80°C	
Storage temperature range		-		- 30 °C	. + 85°C	
Frequency inversion temperature		+ 20	°C		-	
Temperature coefficient of frequency	TC <sub>f</sub> **	-0.036	ppm/K²		-	

<sup>\*)</sup> The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

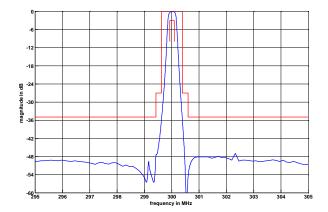
\*\*)  $\Delta f(Hz) = TC_f(ppm/K^2) \times (T-T_0)^2 \times f_{TO}(MHz)$ 

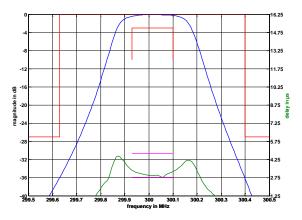
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Checked / Approved:		

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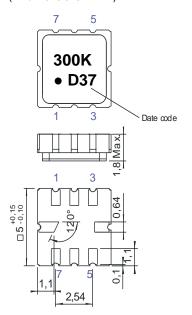
## Filter characteristic





#### Construction and pin connection

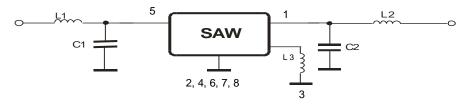
(All dimensions in mm)



1	Output
2	Ground
3	External Coi
4	Ground
5	Input
6	Ground
7	Ground
8	Ground

Date code: Year + week
D 2013
E 2014
F 2015
...

#### 50 Ω Test circuit



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Filter specification

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**TFS 300K** 

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## Stability characteristics, reliability

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 1 ms, half sine wave, 3 shocks each plane;

DIN IEC 68 T2 - 27

2. Vibration: 10 Hz to 500 Hz, 0,35 mm or 5 g respectively, 1 octave per min, 10 cycles per plan, 3 plans;

DIN IEC 68 T2 - 6

3. Change of

Microchip

temperature: -55 °C to 125°C / 15 min. each / 100 cycles

DIN IEC 68 part 2 - 14 Test N

4. Resistance to

solder heat (reflow): reflow possible: three times max.;

for temperature conditions refer to the attached "Air reflow temperature conditions" on page 4;

This filter is RoHS compliant (2011/65/EU)

## **Packing**

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;

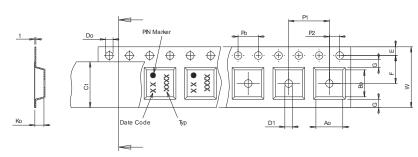
tape type II, embossed carrier tape with top cover tape on the upper side;

max. pieces of filters per reel: 3000 reel of empty components at start: min. 300 mm reel of empty components at start including leader: min. 500 mm trailer: min. 300 mm

Pull Off Direction

#### Tape (all dimensions in mm)

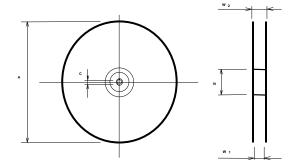
W	:	12,00	$\pm 0.3$
Po	:	4,00	± 0,1
Do	:	1,50	+0,1/-0
E	:	1,75	± 0,1
F	:	5,50	$\pm 0.05$
G(min)	:	0,75	
P2	:	2,00	$\pm 0.05$
P1	:	8,00	± 0,1
D1(min)	:	1,50	
Ao	:	5,30	± 0,1
Во	:	5,30	± 0,1
Ct	:	9,5	$\pm 0,1$



# Reel (all dimensions in mm)

A :330 W1 : 12,4 +2/-0 W2(max) : 18,4

N(min) : 50 C : 13,0 +0,5/-0,2



The minimum bending radius is 45 mm.

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Filter specification

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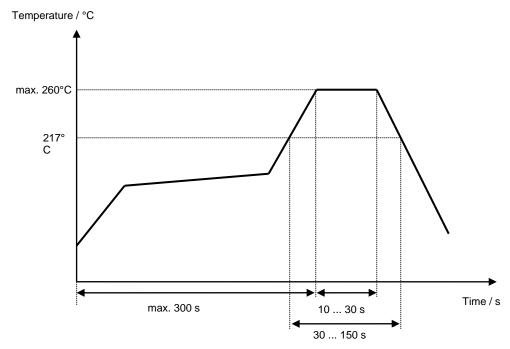
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## Air reflow temperature conditions

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Conditions	Exposure
Average ramp-up rate (30°C to 217°C)	less than 3°C/second
> 100°C	between 300 and 600 seconds
> 150°C	between 240 and 500 seconds
> 217°C	between 30 and 150 seconds
Peak temperature	max. 260°C
Time within 5°C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50°C)	less than 6°C/second
Time from 30°C to Peak temperature	no greater than 300 seconds

# Chip-mount air reflow profile



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History

VersionReason of ChangesNameDate1.0Generation of filter specificationRaura13.09.2013

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